



FOR SEMI

2N7002K

N-Channel Enhancement Mode MOSFET

- Features

For a single mosfet

$V_{DS(V)} = 60V$, $I_D = 0.5A$

$R_{DS(ON)} < 2\Omega$, @ $V_{GS} = 10V$, $I_D = 0.5A$

$R_{DS(ON)} < 4\Omega$, @ $V_{GS} = 4.5V$, $I_D = 0.2A$

Very low level gate drive requirements allowing direct

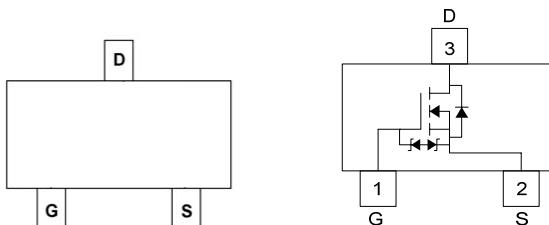
Gate-Source Zener for ESD ruggedness, >2kV Human Body Model

- General Description

These N-Channel logic level enhancement mode field effect transistors are produced using Fairchild's proprietary high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance.

This device has been designed especially for low voltage applications as a replacement for digital transistors. Since bias resistors are not required, these N-Channel FET's can replace several digital transistors, with a variety of bias resistors.

- Pin Configuration



SOT23

- Absolute Maximum Ratings @ $T_A = 25^\circ C$ unless otherwise specified

| Parameter | Symbol | Limit | Unit |
|---|----------------------|------------|------|
| Drain-Source Voltage | V_{DS} | 60 | V |
| Gate-Source Voltage | V_{GS} | ± 20 | V |
| Drain Current-Continuous @ $T_J = 25^\circ C$ | —Continuous | I_D | A |
| | —Pulsed ^b | I_{DM} | A |
| Drain-Source Diode Forward Current ^a | I_S | 0.55 | A |
| Maximum Power Dissipation ^a | P_D | 0.9 | W |
| Operating Junction and Storage Temperature Range | T_J, T_{STG} | -55 to 150 | °C |
| Electrostatic Discharge Rating MIL-STD-883D Human Body Model (100pf / 1500 Ohm) | ESD | 2.0 | KV |

Notes:

- Mounted on a 1in2 FR-4 board with 2oz, Copper in a still air environment at 25°C, the current rating is based on the DC(<10s) test conditions, for each single die.
- Pulse test: Pulse Width<300us,Duty Cycle<2%.



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- Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

| Parameter | Symbol | Test Conditions | Min | Typ | Max | Unit |
|-----------------------------------|-----------------------------|---|-----|------|-----------|---------------|
| Drain-Source Breakdown Voltage | $V_{(\text{BR})\text{DSS}}$ | $V_{GS} = 0V, I_D = 250\mu\text{A}$ | 60 | | -- | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 60V, V_{GS} = 0V$ | -- | | 1 | μA |
| Gate-Body Leakage | I_{GSS} | $V_{GS} = \pm 20V, V_{DS} = 0V$ | -- | | ± 100 | nA |
| Gate Threshold Voltage | $V_{GS(\text{TH})}$ | $V_{DS} = V_{GS}, I_D = 250\mu\text{A}$ | 1.0 | | 2.5 | V |
| Static Drain-Source On-Resistance | $R_{DS(\text{ON})}$ | $V_{GS} = 10V, I_D = 0.5\text{A}$ | | | 2 | Ω |
| | | $V_{GS} = 4.5V, I_D = 0.2\text{A}$ | | | 4 | |
| Forward Transconductance | G_{FS} | $V_{DS} = 10V, I_D = 0.2\text{A}$ | | 0.2 | | S |
| Input Capacitance | C_{ISS} | $V_{DS} = 25V, V_{GS} = 0V$ $F = 1.0\text{MHz}$ | -- | 9.5 | -- | pF |
| Output Capacitance | C_{OSS} | | -- | 6 | | |
| Reverse Transfer Capacitance | C_{RSS} | | | 1.5 | | |
| Total Gate Charge | Q_G | $V_{DS} = 25V, I_D = 0.2\text{A},$ $V_{GS} = 10V$ | | 0.5 | 0.7 | nC |
| Gate-Source Charge | Q_{GS} | | | 0.22 | | |
| Gate-Drain | Q_{GD} | | | 0.07 | | |
| Turn-On Delay Time | $T_{D(\text{ON})}$ | $V_{DD} = 30V, I_D = 0.5\text{A},$ $V_{GS} = 10V, R_{\text{GEN}} = 10\Omega$ | -- | 5 | 10 | nS |
| Turn-Off Delay Time | $T_{D(\text{OFF})}$ | | | 4 | 8 | |
| Turn-On Rise Time | T_r | | | 4.5 | 10 | |
| Turn-Off Fall Time | T_f | | | 3.2 | 7 | |



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- Typical Performance Characteristics

Figure 1. On-Region Characteristics

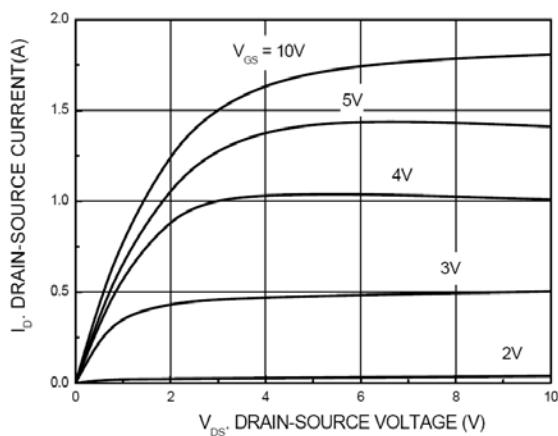


Figure 2. On-Resistance Variation with Gate Voltage and Drain Current

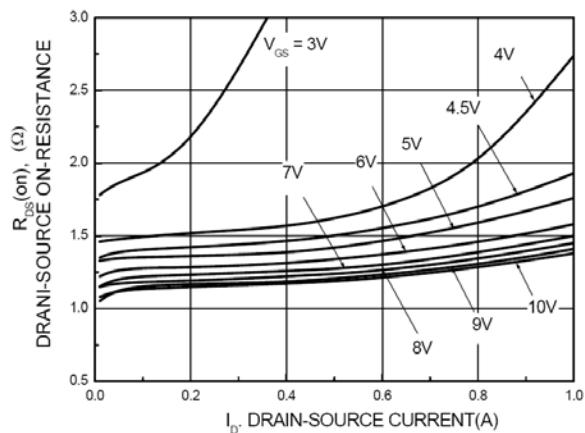


Figure 3. On-Resistance Variation with Temperature

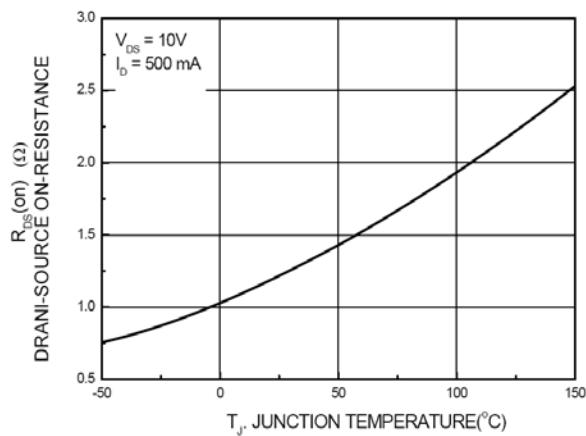


Figure 4. On-Resistance Variation with Gate-Source Voltage

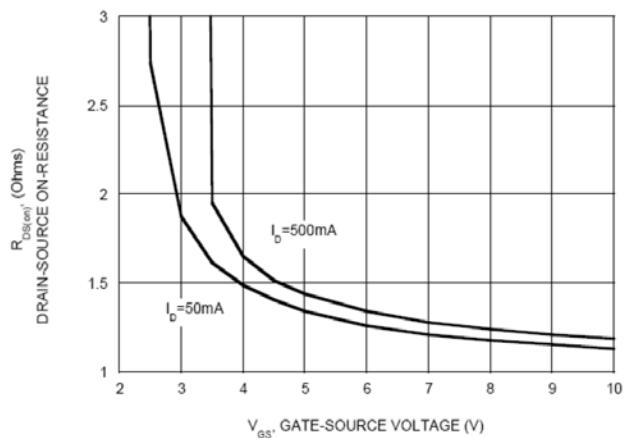


Figure 5. Transfer Characteristics

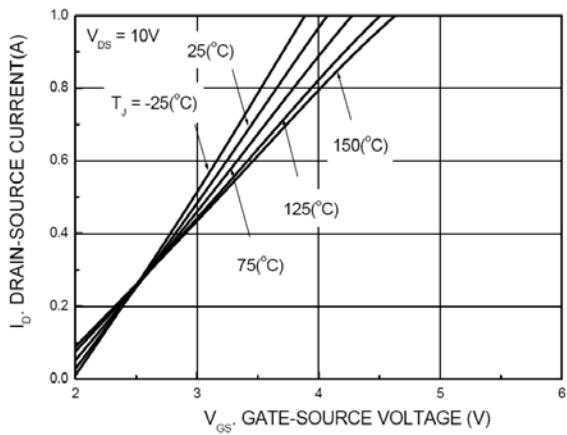
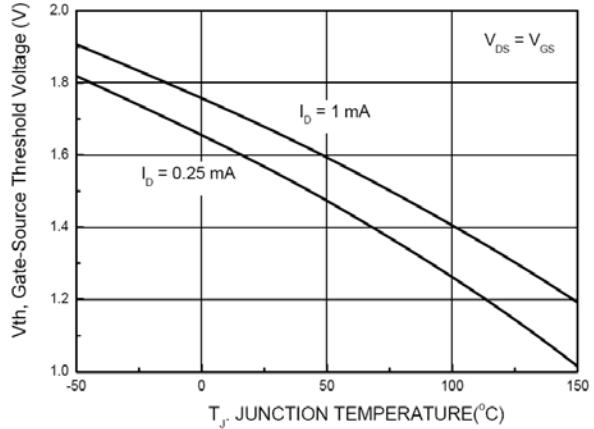


Figure 6. Gate Threshold Variation with Temperature



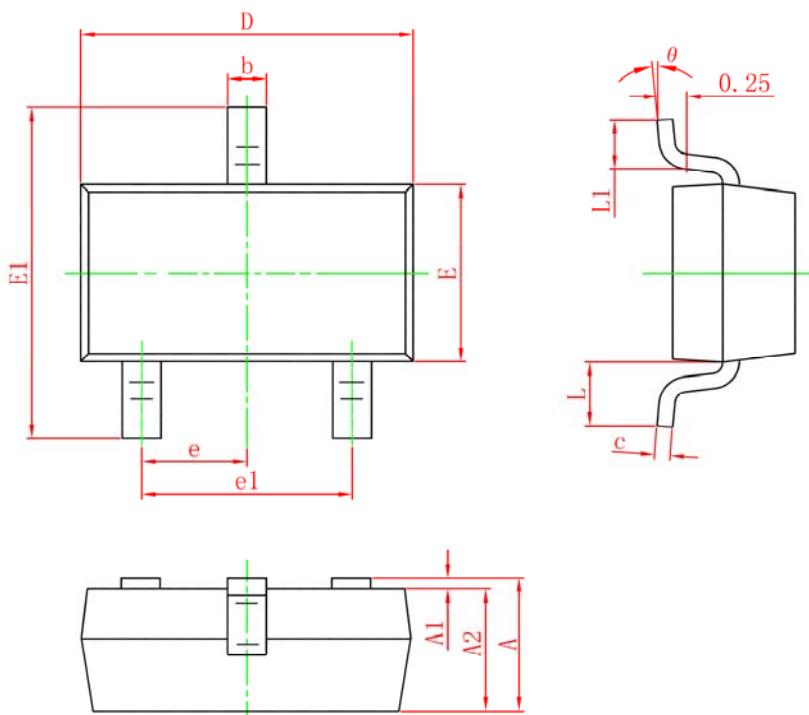


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● Package Information

SOT-23 PACKAGE OUTLINE DIMENSIONS



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|---------|---------------------------|-------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 0.900 | 1.150 | 0.035 | 0.045 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 0.900 | 1.050 | 0.035 | 0.041 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.080 | 0.150 | 0.003 | 0.006 |
| D | 2.800 | 3.000 | 0.110 | 0.118 |
| E | 1.200 | 1.400 | 0.047 | 0.055 |
| E1 | 2.250 | 2.550 | 0.089 | 0.100 |
| e | 0.950 TYP. | | 0.037TYP. | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.550 REF. | | 0.022REF. | |
| L1 | 0.300 | 0.500 | 0.012 | 0.020 |
| θ | 0° | 8° | 0° | 8° |
| UNIT:mm | | | | |